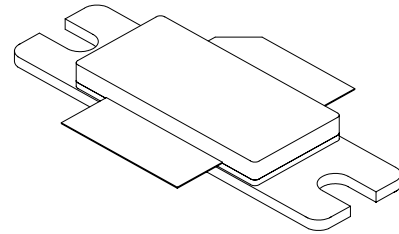


UGF1011-200S

200W PULSE, AVIONICS 1.030-1.090GHz Broadband RF Power N-Channel Enhancement-Mode Lateral DMOS

Avionics LDMOS Transistor. Rated with a minimum output power of 200W, it is ideal for Mode S and TCAS applications in the 1030-1090 MHz frequency band.

- All GOLD metal system for highest reliability
- Industry standard package
- Suggested replacement for L1011-200
- Internally matched (input and output) for repeatable manufacturing
- Class AB Linear Operation
- High gain, high efficiency and high linearity

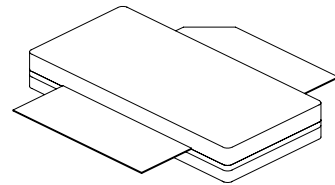


Package Type 440171

PN: UGF1011-200

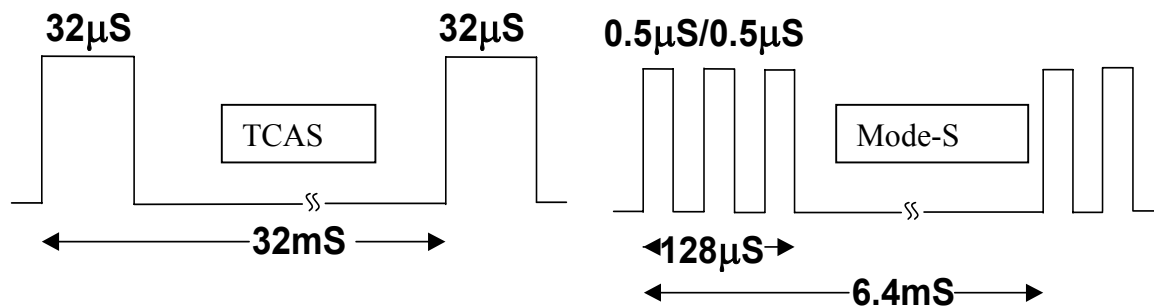
Typical Mode S Performance:

- 200 Watts Peak Power
- $PW = 32\mu s$, $DF = 5\%$
- $V_{DD} = 36V$
- $PAE = 54\%$
- Power Gain – 17dB @ 1090MHz



Package Type 440133

PN: UGF1011-200





Maximum Ratings

Rating	Symbol	Value	Unit
Drain to Source Voltage, gate connected to source	V_{DSS}	70	Volts
Gate to Source Voltage	V_{GSS}	+/- 20	Volts
Total Device Dissipation @ Tcase = 70°C Derate above 70°C (CW)	P_D	250 1.43	Watts W/°C
Storage Temperature Range	T_{stg}	-65 to +150	°C
Operating Junction Temperature	T_J	200	°C

Thermal Characteristics

Characteristics	Symbol	Maximum	Unit
Thermal Resistance, Junction to Case (note 1)	θ_{JC}	0.7	°C/W
Thermal Resistance, Junction to Case (note 2)	θ_{JC}	0.15	°C/W

Note

1. Thermal resistance is determined under RF operating conditions CW; 100%
2. Thermal resistance is determined under RF operating conditions; tp = 32 μ s, DF = 5%

Electrical DC Characteristics (T_C=25°C unless otherwise specified)

Rating	Symbol	Min	Typ	Max	Unit
Drain to Source Voltage, gate connected to source ($V_{GS}=0$, $I_{DS}=1mA$)	BV_{DSS}	70	-	-	Volts
Drain to Source Leakage current ($V_{DS}=36V$, $V_{GS}=0$)	I_{DSS}	-	-	1.0	μA
Gate to Source Leakage current ($V_{GS}=20V$, $V_{DS}=0$)	I_{GSS}	-	-	1.0	μA
Threshold Voltage ($V_{DS}=10V$, $I_{DS}=1mA$)	$V_{GS(th)}$	-	3.0	-	Volts
Gate Quiescent Voltage ($V_{DS}=36V$, $I_{DS}=700mA$)	$V_{GS(Q)}$	3.0	4.0	5.0	Volts
Drain to Source On Voltage ($V_{GS}=10V$, $I_{DS}=1A$)	$V_{DS(on)}$	-	0.075	0.1	Volts
Forward Transconductance ($V_{DS}=10V$, $I_{DS}=5A$)	Gm	-	5.0	-	S



UGF1011-200S

AC Characteristics ($T_C = 25^\circ\text{C}$ unless otherwise specified)

Rating	Symbol	Min	Typ	Max	Unit
Output capacitance * ($V_{DS} = 36\text{V}$, $V_{GS} = 0\text{V}$, freq= 1MHz)	C_{OSS}	-	100	-	pF
Feedback capacitance * ($V_{DS} = 36\text{V}$, $V_{GS} = 0\text{V}$, freq= 1MHz)	C_{RSS}	-	6.0	-	pF

* for reference only, device is input and output matched

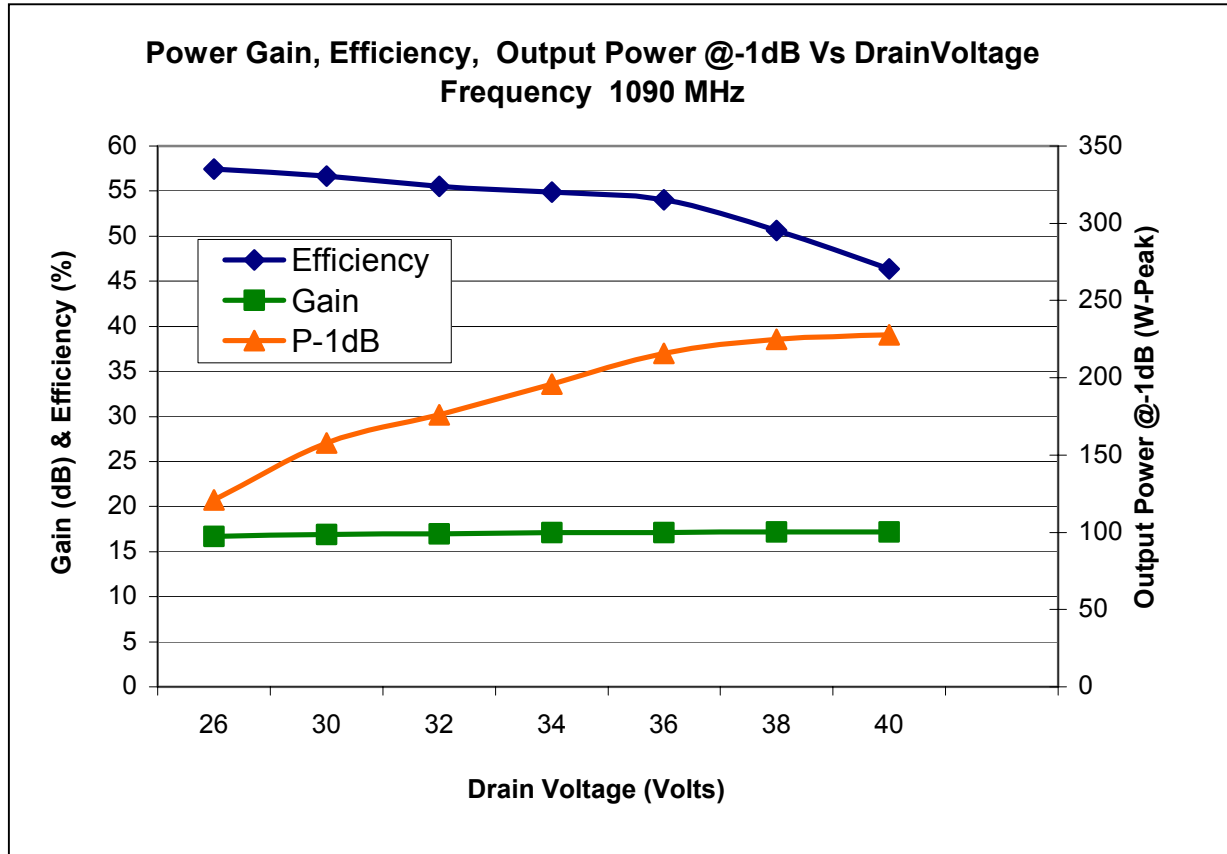
RF and Functional Tests ($T_C = 25^\circ\text{C}$ unless otherwise specified, Cree Microwave Broadband Fixture)

Rating	Symbol	Min	Typ	Max	Unit
Pulsed Class AB Common Source Amplifier Power Gain $V_{DD} = 36\text{V}$, $I_{DQ} = 700\text{mA}$, $P_{out} = 200\text{ W Peak}$ * $f = 1090\text{ MHz}$	G_{PS}	15.0	17	-	dB
Pulse Drain Efficiency $V_{DD} = 36\text{V}$, $I_{DQ} = 700\text{mA}$, $P_{out} = 200\text{ W Peak}$ * $f = 1090\text{ MHz}$	η	50	54	-	%
P_{out} , 1dB Compression Point $V_{DD} = 36\text{V}$, $P_{out} = 200\text{ W Peak}$ * $f = 1090\text{ MHz}$	P_{1dB}	-	200	-	
Input Return Loss $V_{DD} = 36\text{V}$, $I_{DQ} = 700\text{mA}$, $P_{out} = 200\text{ W Peak}$ * $f = 1090\text{ MHz}$	IRL	-	-10	-	dB
Load Mismatch Tolerance ($V_{ds} = 36\text{V}$, $I_{dq} = 700\text{ mA}$, $P_{out} = 200\text{W Peak}$ * $f = 1030\text{ MHz}$)	VSWR	3:1	-	-	Ψ

*RF Peak Operating Conditions -- $32\mu\text{s}$, $DF = 5\%$

CAUTION - MOS Devices are susceptible to damage from Electrostatic Discharge (ESD). Appropriate precautions in handling, packaging and testing MOS devices must be observed.

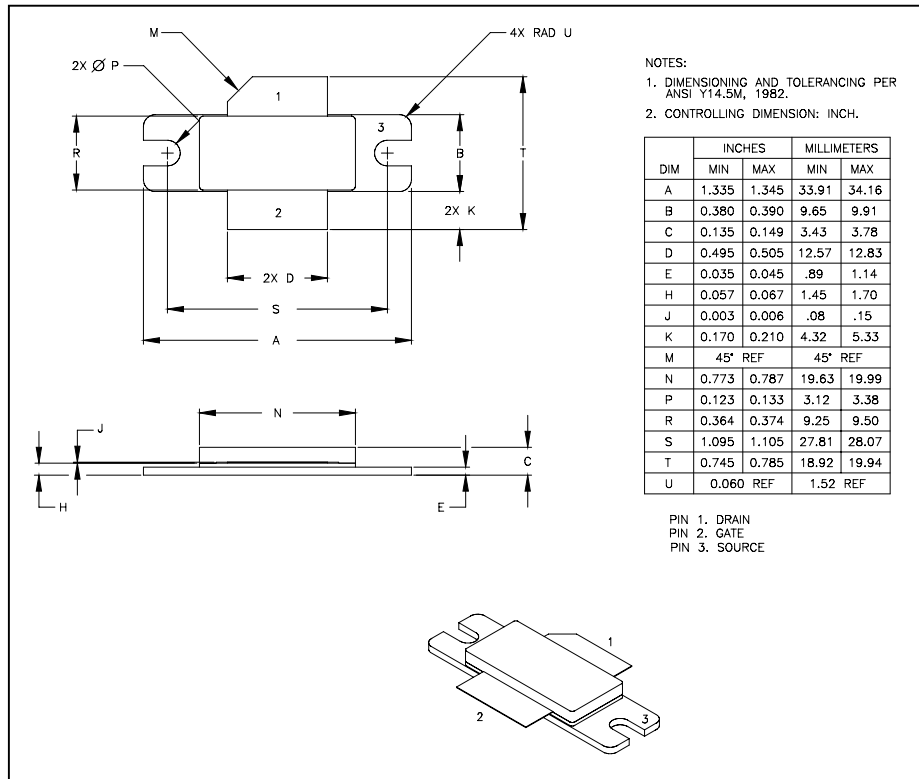
Frequency 1090 MHz
Pulse Width 32μs Duty cycle = 5%



V _{DD} (V)	P _{in} (dBm)	P _G (dB)	P _{out} @ -1dB	I _D (A)	Efficiency (%)
26	31.7	16.7	121	1.07	57.45
30	32.5	16.9	158	1.13	56.63
32	33.1	17.0	176	1.16	55.56
34	33.6	17.1	196	1.19	54.90
36	33.9	17.1	216	1.22	54.05
38	34.1	17.2	225	1.25	50.61
40	34.4	17.2	228	1.28	46.34

Package Dimensions

Package Number 440171



Package Number 440133

